

Specification for Approval

DEVICE NUMBER: BL-2835N10-34-R80

SAMPLES ATTACHED AREA

| PAGE DATE | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | CONTENTS |
|--------------|-----|-----|-----|-----|-----|-----|-----|-----|-----|------------------|
| 2017.10.13 | 1.0 | 1.0 | 1.0 | 1.0 | 1.0 | 1.0 | 1.0 | 1.0 | 1.0 | Initial Released |
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FOR CUSTOMER'S APPROVAL STAMP OR SIGNATURE

| APPROVED | PURCHASE | MANUFACTURE | QUALITY | ENGINEERING |
|----------|----------|-------------|---------|-------------|
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| ISSUED | APPROVED | PREPARED |
|--------|----------|----------|
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Features:

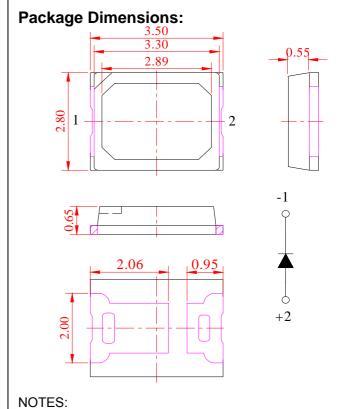
1. Emitted Color: White.

CCT: 3710~4745K

- 2. Lens Appearance: Yellow clear.
- 3. 3.5*2.8*0.65mm standard package.
- 4. Suitable for all SMT assembly methods.
- 5. Compatible with infrared and vapor phase reflow solder process.
- 6. Compatible with automatic placement equipment.
- 7. This product doesn't contain restriction Substance, comply ROHS standard.

Applications:

- 1. Lighting
- 2. Automotive lighting.
- 3. Backlighting: LCDs
- 4. Status indicators: Consumer & industrial electronics.
- 5. General use.



- 1.All dimensions are in millimeters.
- 2. Tolerance is ±0.10mm unless otherwise specified.
- 3. Specifications are subject to change without notice.

■ Absolute Maximum Ratings(Ta=25°C)

| Parameter | Symbol | Rating | Unit |
|--------------------------|-----------------|------------|------------------------|
| Power Dissipation | Pd | 500 | mW |
| Forward Current | I _F | 180 | mA |
| *1Peak Forward Current | I _{FP} | 270 | mA |
| LED Junction Temperature | Τ _J | 115 | $^{\circ}\!\mathbb{C}$ |
| Operating Temperature | Topr | -40~+85 | $^{\circ}$ |
| Storage Temperature | Tstg | -40~+100 | $^{\circ}$ |
| Soldering Temperature | Tsol | See Page 7 | - |

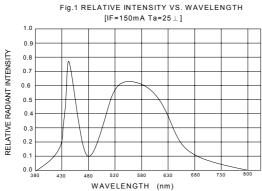
Note: IFP is pulse of 1/10 duty at 1KHz

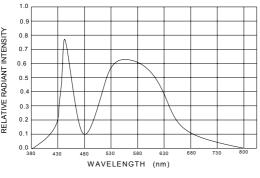


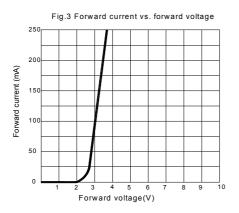
Electrical and optical characteristics(Ta=25°℃)

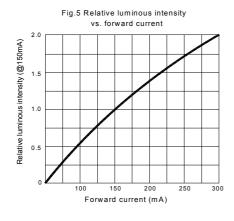
| T | | | | | | ī. |
|-----------------------|-------------------|-----------------------|-------|------|------|------|
| Parameter | Symbol | Condition | Min. | Тур. | Max. | Unit |
| Forward Voltage | Vf | | 2.8 | - | 3.3 | V |
| Luminous Intensity | lv | | 30000 | - | - | mcd |
| Luminous Flux | Фу | | 60 | 66 | - | lm |
| Chromaticity | Х | I _F =150mA | - | 0.37 | - | |
| Coordinates | y | 1F = 130111A | - | 0.37 | - | _ |
| Color Temperature | CCT | | 3710 | - | 4745 | K |
| Color Rendering Index | CRI | | 80 | - | _ | |
| Viewing Angle | 2θ _{1/2} | | - | 120 | - | deg |

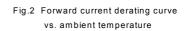
Typical Electro-Optical Characteristics Curves.

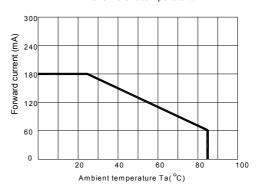


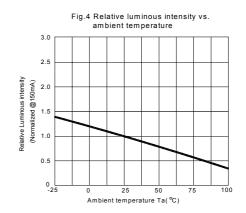


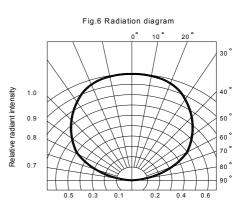






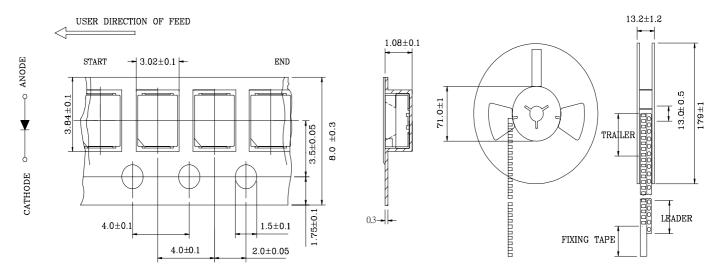






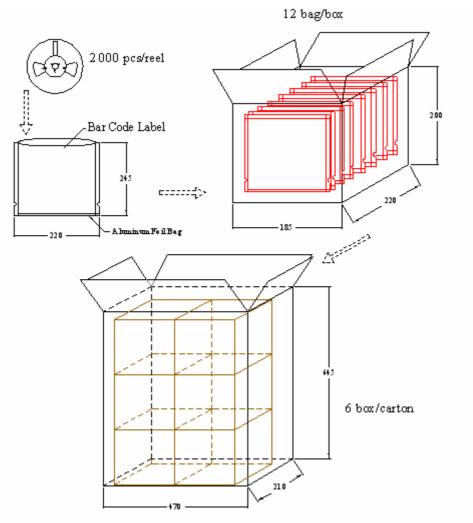


Tapping and packaging specifications(Units: mm)



NOTE:2000 PCS PER REEL

Package Method:(unit:mm)





Intensity Bin Limits (At 150 mA)

| BIN CODE | Min. (mcd) | Max. (mcd) | Min. (Lm) | Max. (Lm) |
|----------|------------|------------|-----------|-----------|
| R | 30000 | 32500 | 60 | 65 |
| S | 32500 | 35000 | 65 | 70 |
| Т | 35000 | 37500 | 70 | 75 |

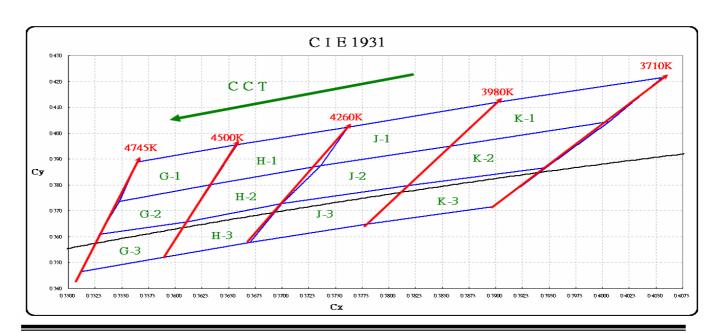
Tolerance for each Bin limit is ±10%.

Forward Voltage Bin Limits (At 150 mA)

| BIN CODE | Min.(v) | Max.(v) |
|----------|---------|---------|
| Υ | 2.8 | 2.9 |
| Z | 2.9 | 3.0 |
| Α | 3.0 | 3.1 |
| В | 3.1 | 3.2 |
| С | 3.2 | 3.3 |

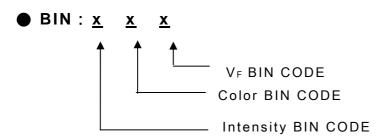
Tolerance for each Bin limit is ± 0.02V.

Color Temperature Bin Limits (At 150mA)





| BIN | CCT(F | ζ) | | C | hromaticit | y Coordin | ates | |
|-------|--------------|--------------|---|--------|------------|-----------|--------|--------|
| G-1 | | | Х | 0.3634 | 0.3548 | 0.3564 | 0.3658 | 0.3634 |
| 0-1 | | | у | 0.3801 | 0.3736 | 0.3888 | 0.3956 | 0.3801 |
| G-2 | | 4500-4745K | Х | 0.3611 | 0.3529 | 0.3548 | 0.3634 | 0.3611 |
| | | 1000 11 1011 | у | 0.3658 | 0.3609 | 0.3736 | 0.3801 | 0.3658 |
| G-3 | | | Х | 0.3589 | 0.3512 | 0.3529 | 0.3611 | 0.3589 |
| | 4500K | | у | 0.3520 | 0.3465 | 0.3609 | 0.3658 | 0.3520 |
| H-1 | (4260-4745K) | | Х | 0.3736 | 0.3634 | 0.3658 | 0.3762 | 0.3736 |
| ** 1 | | | у | 0.3874 | 0.3801 | 0.3956 | 0.4024 | 0.3874 |
| H-2 | | 4260-4500K | х | 0.3700 | 0.3611 | 0.3634 | 0.3736 | 0.3700 |
| | | | у | 0.3728 | 0.3658 | 0.3801 | 0.3874 | 0.3728 |
| H-3 | | | Х | 0.3670 | 0.3589 | 0.3611 | 0.3700 | 0.3670 |
| | | | у | 0.3578 | 0.3520 | 0.3658 | 0.3728 | 0.3578 |
| J-1 | | 3980-4260K | Х | 0.3780 | 0.3670 | 0.3700 | 0.3818 | 0.3780 |
| | | | у | 0.3649 | 0.3578 | 0.3728 | 0.3797 | 0.3649 |
| J - 2 | | | Х | 0.3818 | 0.3700 | 0.3736 | 0.3857 | 0.3818 |
| | | | у | 0.3797 | 0.3728 | 0.3874 | 0.3949 | 0.3797 |
| J-3 | | | Х | 0.3857 | 0.3736 | 0.3762 | 0.3902 | 0.3857 |
| | 4000K | | У | 0.3949 | 0.3874 | 0.4024 | 0.4120 | 0.3949 |
| K-1 | (3710-4260K) | | Х | 0.4006 | 0.3857 | 0.3902 | 0.4056 | 0.4006 |
| | | | у | 0.4044 | 0.3949 | 0.4120 | 0.4215 | 0.4044 |
| K-2 | | 3710-3980K | Х | 0.3947 | 0.3818 | 0.3857 | 0.4006 | 0.3947 |
| | | | у | 0.3867 | 0.3797 | 0.3949 | 0.4044 | 0.3867 |
| K-3 | | | Х | 0.3898 | 0.3780 | 0.3818 | 0.3947 | 0.3898 |
| | | | у | 0.3716 | 0.3649 | 0.3797 | 0.3867 | 0.3716 |



Notes:

- 1. Iv: Tolerance for each Bin limit is ± 10 %
- 2. Color: Tolerance for each Bin limit is ±0.005
- 3. Bin categories are established for classification of products.

Products may not be available in all bin categories



Reliability Test

| Test Item | Test Conditions | Test Hours/ Cycles | Result |
|--|---|-----------------------|--------|
| Steady State Operating Life of High Temperature | I _F =150mA Ta=60°ℂ | 1,000hrs | 0/20 |
| Steady State Operating Life | I _F =150mA Ta=25°ℂ | 3,000hrs | 0/20 |
| Steady State Operating Life Low Temperature Condition1 | I _F =150mA Ta=-30°ℂ | 1,000hrs | 0/20 |
| Steady State Operating Life Of High Humidity Heat | I _F =150mA Ta=60°C RH=75% | 1,000hrs | 0/20 |
| Thermal shock | -45°C ~+125°C 30 min 30 min | 100cycle | 0/20 |
| Temperature &Humidity Cycling | Ta=25°C ~ +65°C ~ -10°C RH=90%RH,24hr/1cycle | 1cycle | 0/20 |
| Resistance to Soldering Heat | Tsld=260°C,10sec(Pre treatment30°C,70%,168hrs) | 2times | 0/20 |
| ESD(HBM) | -R1:10 K Ω ,R2:1.5 K Ω ,C:100 pF Discharge Time:3 times | Min.2KV | 0/5 |

Judgment criteria of failure for the reliability

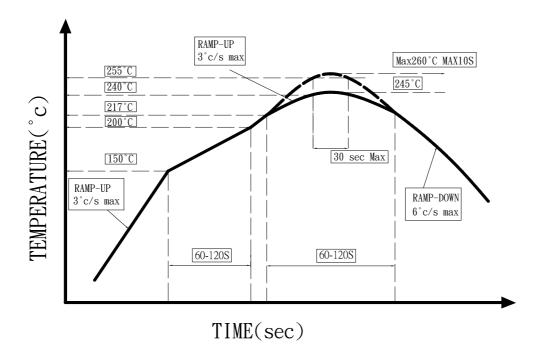
| Measuring items | Symbol | Measuring conditions | Judgment criteria for failure |
|--------------------|------------|-----------------------|-------------------------------|
| Forward voltage | $V_{F}(V)$ | I _F =150mA | Over U ¹ x1.2 |
| Reverse current | $I_R(uA)$ | V _R =5V | Over U ¹ x2 |
| Luminous intensity | lv (mcd) | I _F =150mA | Below S ¹ X0.5 |

Note: 1. U means the upper limit of specified characteristics. S means initial value.

2. After each test, remove test pieces, wait for 2 hours and test pieces have returned to ambient temperature, then take next measurement.

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●IR-Reflow



- 1. Avoid any external stress applied to the resin while the LEDs are at high temperature, especially during soldering.
- 2. Avoid rapid cooling or any excess vibration during temperature ramp-down process
- Although the soldering condition is recommended above, soldering at the lowest possible temperature is feasible for the LEDs
- ●IRON Soldering 350°C Within 3 sec, one time only.



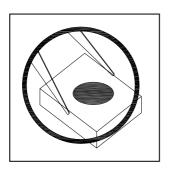
Handling Precautions

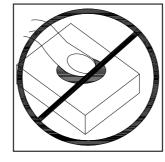
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force.

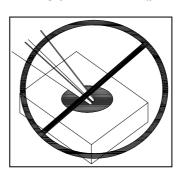
As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

- 1. Handle the component along the side surfaces by using forceps or appropriate tools.(pic.1)
- 2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry. (pic.2,pic.3)
- 3. Do not stack together assembled PCBs, containing exposed LEDs. Impact may scratch the silicone lens or damage the internal circuitry. (pic.4)
- 4. The outer diameter of the SMD pickup nozzle should not exceed the size of the LED to prevent air leaks. The inner diameter of the nozzle should be as large as possible. (pic.5)
- 5. A pliable material is suggested for the nozzle tip to avoid scratching or damaging the LED surface during pickup. (pic.5)

 6. The dimensions of the component must be accurately programmed in the pick-and-place
- machine to insure precise pickup and avoid damage during production. (pic.5)



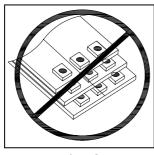




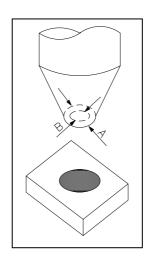
Pic.1

Pic.2

Pic.3







Pic.5



Notes for designing:

Care must be taken to provide the current limiting resistor in the circuit so as to drive the LEDs within the rated figures. Also, caution should be taken not to overload LEDs with instantaneous voltage at the turning ON and OFF of the circuit.

When using the pulse drive care must be taken to keep the average current within the rated figures. Also, the circuit should be designed so as be subjected to reverse voltage when turning off the LEDs.

Storage:

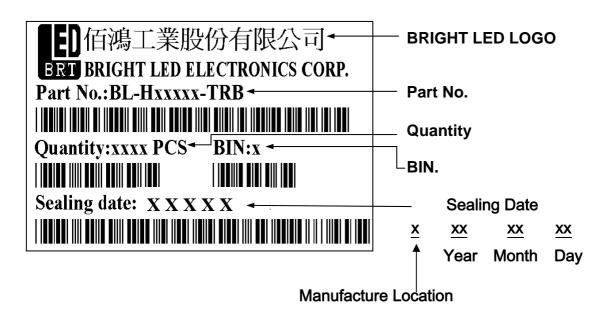
In order to avoid the absorption of moisture, it is recommended to solder LEDs as soon as possible after unpacking the sealed envelope.

If the envelope is still packed, to store it in the environment as following:

- (1) Temperature: 5°C-30°C(41°F)Humidity: RH 60% Max.
- (2) After this bag is opened, devices that will be applied to infrared reflow, vapor-phase reflow, or equivalent soldering process must be:
- a. Completed within 24 hours.
- b. Stored at less than 20% RH.
- (3) Devices require baking before mounting, if: 2a or 2b is not met.
- (4) If baking is required, devices must be baked under below conditions: 48 hours at 60°C±5°C.

Package and Label of Products:

Package: Products are packed in one bag of 2000 pcs (one taping reel) and a label is attached to each bag. Label:



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